

REMARKS

Claims 1-12 are pending in the Application. Claims 1-3, 5-8, and 11 are amended, and claim 10 is canceled without prejudice, its limitations having been incorporated into claim 5 from which it depends. Claim 13 is newly presented. Applicant requests reconsideration and allowance in view of the above amendments and the following remarks.

Claim Objections

Claims 1-3, 5, and 6-7 are objected to based on certain grammatical informalities. Applicant appreciates the Examiner's careful attention to the claims and suggestions for correcting those informalities, and has amended the claims accordingly. Therefore, Applicant respectfully submits that the objection is overcome.

Rejection Under 35 U.S.C. § 112

Claims 1-12 are rejected under 35 U.S.C. § 112, second paragraph, as allegedly being indefinite. According to the Office Action, it is unclear what is meant in claims 1 and 5, the two independent claims, by recitation that the motherboards are "greater" than the substrates. As the Examiner correctly understands, by "greater than," it was meant that the motherboards are larger than the substrates. Pursuant to the Examiner's suggestion, the term "greater than" has been amended to "larger than" in both of claims 1 and 5. Applicant respectfully submits that such amendment is a matter of specific terminology only and gives up no scope of protection. Applicant respectfully requests that the rejection be withdrawn.

Rejections Under 35 U.S.C. § 103

Claims 1-4 are rejected under 35 U.S.C. § 103 as allegedly being unpatentable over Yamamoto et al. (JP5-165037) in view of the collective teachings of Furushima et al. (U.S. Patent No. 5,410,423) and Nishiguchi et al. (U.S. Patent No. 6,226,067), and also in view of the collective teachings of Furushima et al. and Sasaki (U.S. Patent No. 6,573,972). Similarly, claims 5-12 are rejected under 35 U.S.C. § 103 as allegedly being unpatentable over Yamamoto et al. in view of the Admitted Prior Art discussed in the Application, the collective teachings of Furushima et al. and Nishiguchi et al., and also in view of the

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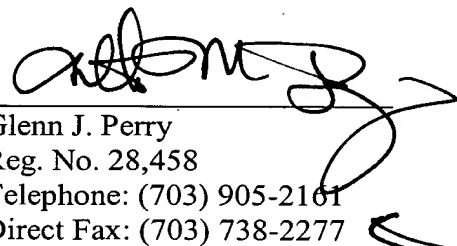

collective teachings of Furushima et al. and Sasaki. Applicant respectfully requests reconsideration and withdrawal of the rejections.

As amended, the claims require that a dummy sealant covering spacers be arranged on end portions of the motherboard, except corner portions thereof, and that tacker covering end spacers be arranged on the corner portions of the motherboard; that the sealant and the dummy sealant be formed individually of materials cured by the same method, while the dummy sealant and the tacker be formed individually of materials cured by different methods; and that the two motherboards be finally bonded to each other by curing the sealant and the dummy sealant after the tacking has been cured. Applicant respectfully submits that none of the references, either individually or in combination, discloses or suggests all features recited in the claims. Accordingly, Applicant respectfully requests that the rejections be withdrawn.

In view of the foregoing, Applicant respectfully submits that all claims are in condition for allowance, and timely Notice to that effect is respectfully requested.

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Respectfully submitted,

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